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Vishay Semiconductors

High Speed Infrared Emitting Diodes, 940 nm, **Surface Emitter Technology**



DESCRIPTION

As part of the SurfLight™ portfolio, the VSMY12940 is an infrared, 940 nm, top looking emitting diode based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted PCB based package (with inner lens) for surface mounting (SMD).

APPLICATIONS

- Photointerrupters
- · Optical switch

FEATURES

· Package type: surface mount

· Package form: top view

• Dimensions (L x W x H in mm): 3.2 x 1.6 x 1.1

Peak wavelength: λ_p = 940 nm

High reliability

- High radiant power
- · Very high radiant intensity
- Angle of half intensity: $\varphi = \pm 40^{\circ}$
- · Suitable for high pulse current operation
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





RoHS COMPLIANT HALOGEN FREE **GREEN**

- Emitter for proximity applications
- · IR touch panels

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSMY12940	16	± 40	940	10

Note

· Test conditions see table "Basic Characteristics"

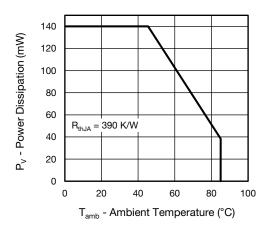
ORDERING INFORMATI	ON		
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMY12940	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	Top view

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	70	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	Α	
Power dissipation		P _V	140	mW	
Junction temperature		T _j	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	acc. figure 10, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction/ambient	J-STD-051, soldered on PCB	R _{thJA}	390	K/W	

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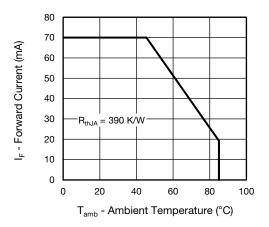


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.1	1.4	1.9	V
Forward voltage	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}		1.6		V
	$I_F = 1 \text{ A, } t_p = 100 \mu\text{s}$	V _F		2.8		V
Temperature coefficient of V _F	I _F = 20 mA	TK _{VF}		-1.7		mV/K
Reverse current		I _R	not designed for reverse operation		μA	
Junction capacitance	$V_R = 0 \text{ V, f} = 1 \text{ MHz, E} = 0 \text{ mW/cm}^2$	CJ		5		pF
Radiant intensity	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	l _e	2.3	4.7		mW/sr
	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	l _e		16		mW/sr
	$I_F = 1 \text{ A, } t_p = 100 \mu\text{s}$	l _e		130		mW/sr
Radiant power	$I_F = 70 \text{ mA}, t_p = 20 \text{ ms}$	φ _е		40		mW
Temperature coefficient of radiant power	I _F = 20 mA	ТКфе		-0.19		%/K
Angle of half intensity		φ		± 40		deg
Peak wavelength	I _F = 20 mA	λρ	920	940	960	nm
Spectral bandwidth	I _F = 20 mA	Δλ		35		nm
Temperature coefficient of λ _p	I _F = 20 mA	$TK\lambda_p$		0.25		nm/K
Rise time	I _F = 100 mA, 20 % to 80 %	t _r		10		ns
Fall time	I _F = 100 mA, 20 % to 80 %	t _f		10		ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

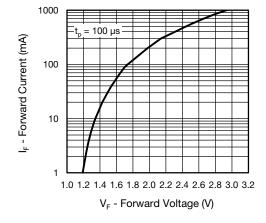


Fig. 3 - Forward Current vs. Forward Voltage

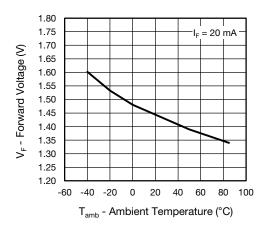


Fig. 4 - Forward Voltage vs. Ambient Temperature



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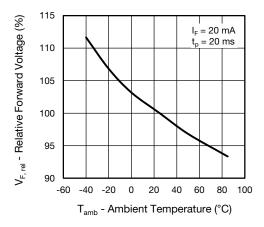


Fig. 5 - Relative Forward Voltage vs. Ambient Temperature

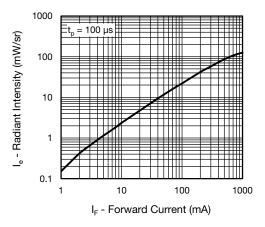


Fig. 6 - Radiant Intensity vs. Forward Current

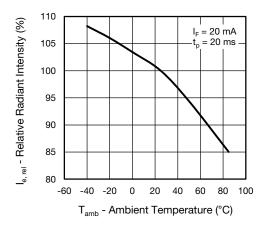


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

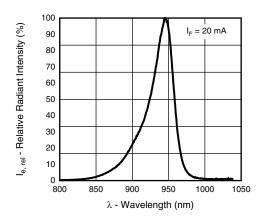


Fig. 8 - Relative Radiant Intensity vs. Wavelength

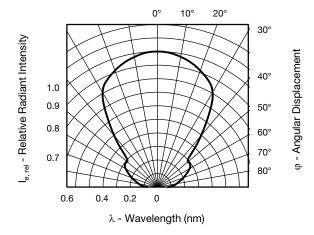


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement



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SOLDER PROFILE

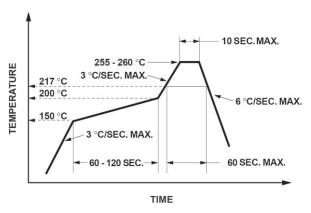


Fig. 10 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

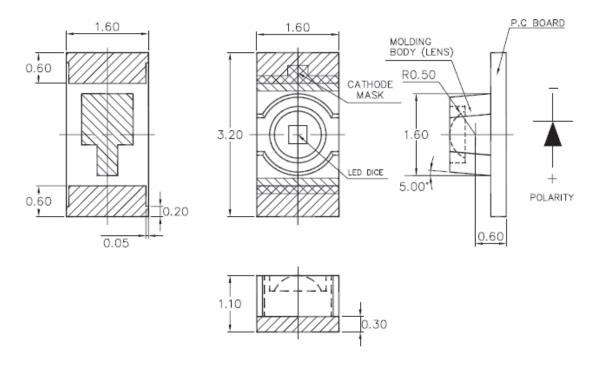
Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020.

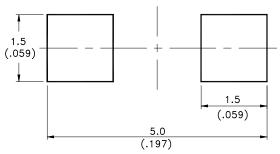
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

PACKAGE DIMENSIONS in millimeters: VSMY12940



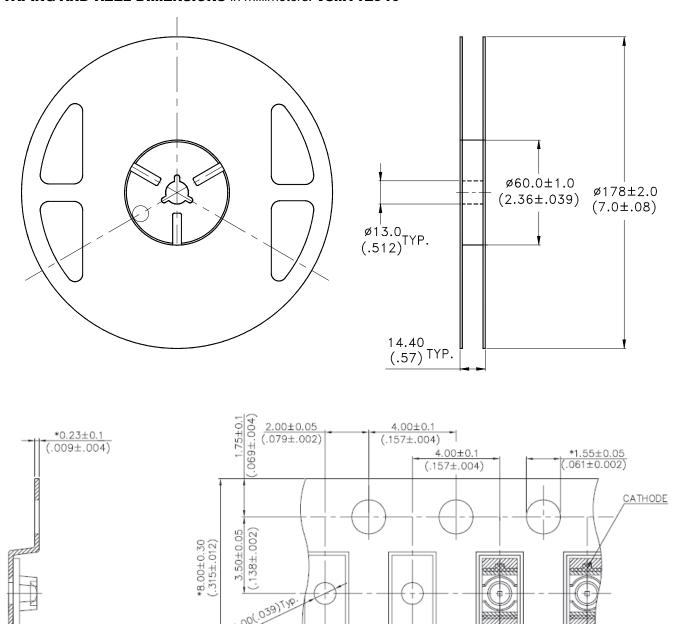
Recommended Solder Pad



*1.30±0.10(.051±.004)

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TAPING AND REEL DIMENSIONS in millimeters: VSMY12940



User Feed Direction



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